

Preamplifier Circuit for IR Remote Control



MECHANICAL DATA

Pinning:

- 1, 4, 5= N.C.,
- 2 = V_S ,
- 3 = OUT,
- 6, 8 = GND,
- 7 = IN

FEATURES

- Carrier-out-function: carrier frequency and burst length accurately correspond to the input signal
- Small QFN package with 2 mm width
- Can be used with either a photodiode or an IR emitter in forward or reverse polarity
- AC coupled input is insensitive to DC photocurrents
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

RoHS
COMPLIANT
GREEN
(5-2008)

ESD

- To maximize the sensitivity, the TIA input pin has minimal ESD protection. Care should be taken never to touch or otherwise expose this pin to an adverse ESD source. The ESD protection conforms to Class 1B.

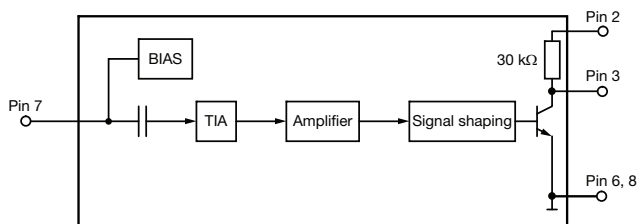
DESCRIPTION

The VSOP98260 is designed for use in an IR learning application together with a photo PIN diode or IR LED as optical detector. It is compatible with all data formats for IR remote control. On the other hand it is immune to current caused by light sources such as tungsten bulbs or fluorescent lamps.

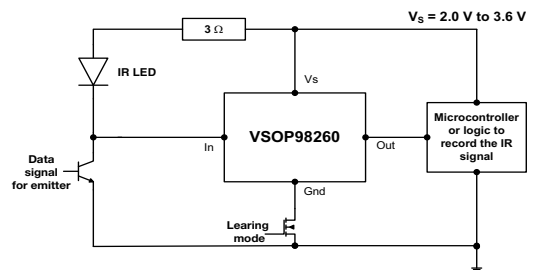
PARTS TABLE

CARRIER FREQUENCY	PART NUMBER
20 kHz to 60 kHz	VSOP98260

BLOCK DIAGRAM (simplified)



APPLICATION CIRCUIT



Recommended to minimize the connection distance between the IR LED and the input of the VSOP98260, and if possible to shield this connection to Gnd.

Note

- (1) For further information, see application note, "IC for Code Learning Applications"

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage	Pin 2	V_S	- 0.3 to + 6	V
Supply current	Pin 2	I_S	5	mA
Output voltage	Pin 3	V_O	- 0.3 to ($V_S + 0.3$)	V
Output current	Pin 3	I_O	5	mA
Input voltage	Pin 7	V_I	- 0.3 to 3.3	V
Input current	Pin 7	I_I	7	mA
Power dissipation	$T_{amb} \leq 85\text{ }^{\circ}\text{C}$	P_{tot}	10	mW
Operating temperature range		T_{amb}	- 25 to + 85	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 25 to + 85	$^{\circ}\text{C}$
ESD stress, HBM	Pin 2, pin 3, MIL-STD-883C	V_{ESD}	2000	V
	Pin 7, MIL-STD-883C	V_{ESD}	500	V
ESD stress, MM	Pin 2, pin 3, MIL-STD-883C	V_{ESD}	200	V
	Pin 7, MIL-STD-883C	V_{ESD}	100	V

Note

- Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL CHARACTERISTICS ($T_{amb} = 5\text{ }^{\circ}\text{C}$ to + 85 $^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		V_S	2.0		3.6	V
Supply current (pin 2)	$I_{IN} = 0, V_S = 5\text{ V}$	I_S	0.55	0.7	0.9	mA
Output voltage low (pin 3)	$I_{OL} = 2\text{ mA}$	V_{OL}			100	mV
Output voltage high (pin 3)	$I_{OL} = 0$	V_{OH}	$V_S - 0.25$			V
Internal pull up resistor (pin 2, pin 3)		R_{PU}		33		k Ω
Max. input DC current	$V_{IN} > 0$	$I_{IN-DCmax.}$	400			μA
Min. signal detection current	$I_{IN-DC} = 0, f_C = f_{BPF}$	$I_{IN-min.}$		40	80	nA
	$I_{IN-DC} = 100\text{ }\mu\text{A}, f_C = f_{BPF}$	$I_{IN-min.}$		50		nA
Output accuracy	$f_C = 20\text{ kHz to }60\text{ kHz}$, $I_{IN} = 80\text{ nA to }50\text{ }\mu\text{A}$, testsignal see fig. 1, BER $\leq 2\%$	N carrier pulses	input burst length - 1 cycle	input burst length	input burst length + 1 cycle	counts

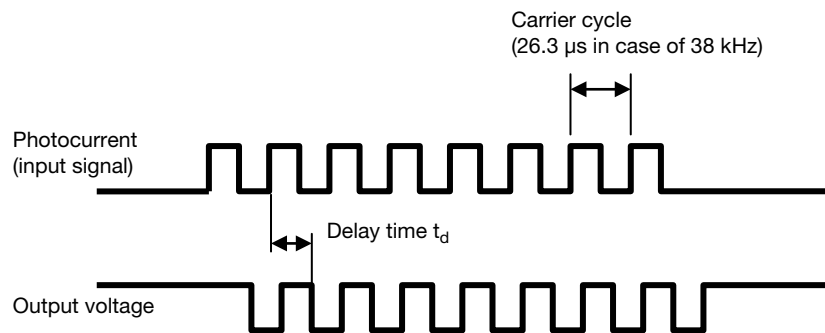
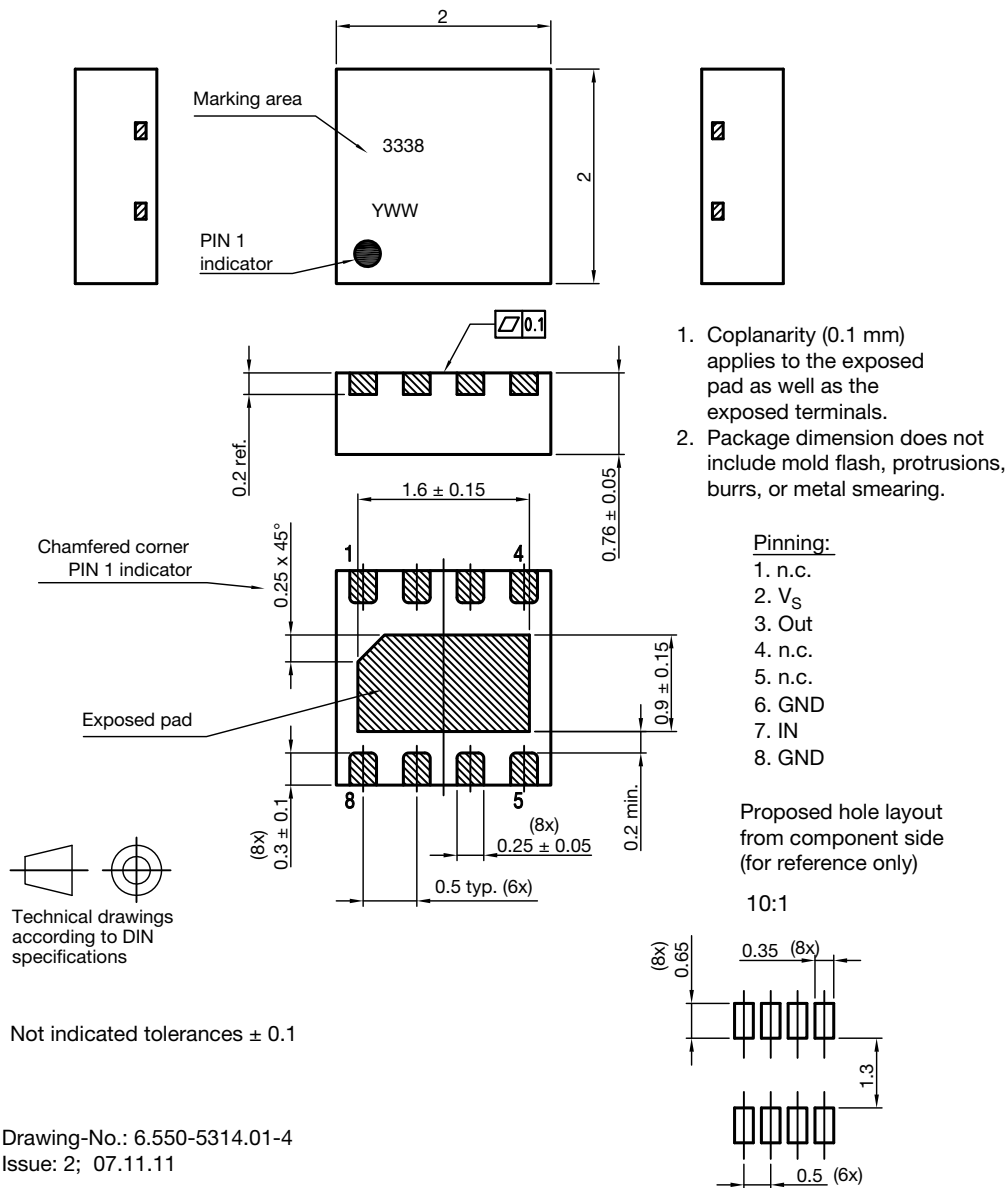


Fig. 1 - Testsignal

PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.550-5314.01-4
Issue: 2; 07.11.11

ASSEMBLY INSTRUCTIONS

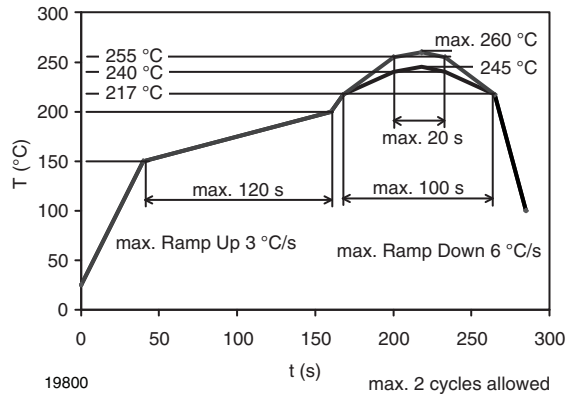
Reflow Soldering

- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

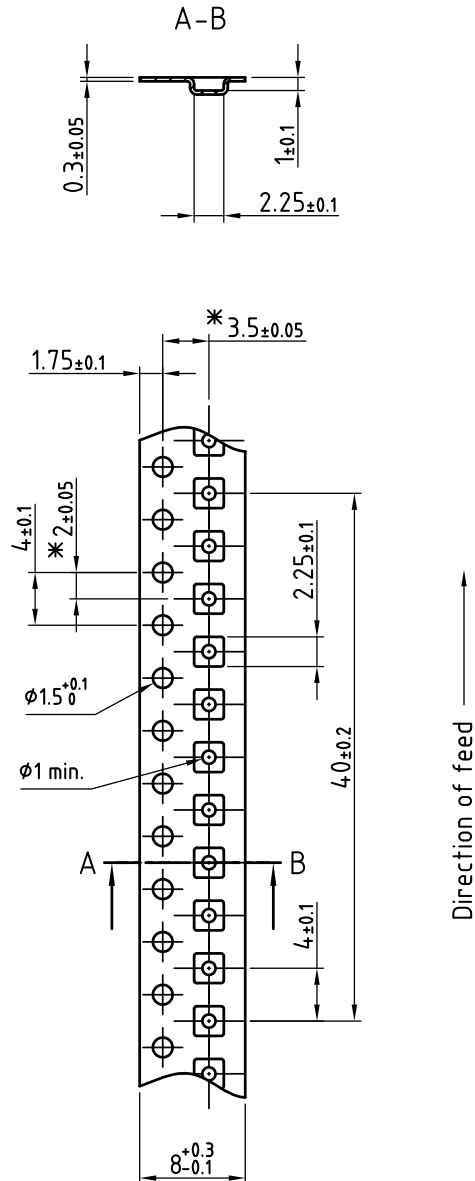
Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off.

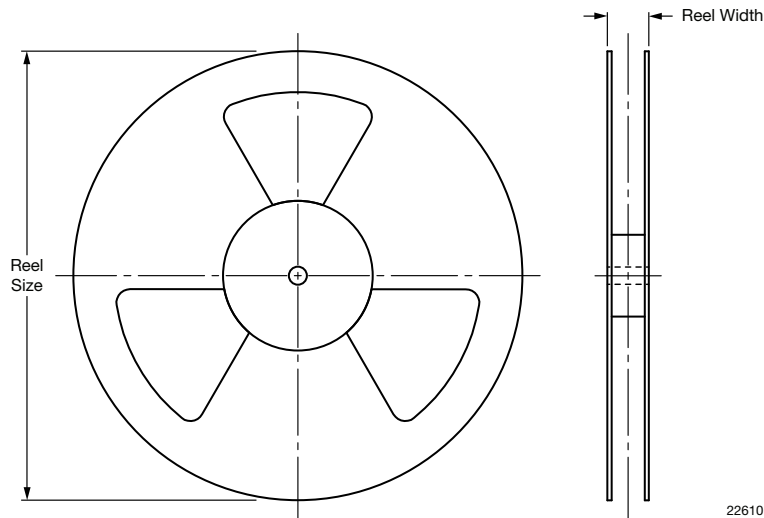
VISHAY LEAD (PB)-FREE REFLOW SOLDER PROFILE



TAPING VERSION VSOP DIMENSIONS in millimeters



* Measured from centerline of sprocket hole to centerline of pocket

REEL DIMENSIONS in millimeters


REEL		TRAILER LENGTH (mm)	LEADER LENGTH (mm)	QUANTITY PER REEL
REEL SIZE (inch)	REEL WIDTH (mm)			
7	8.4	160	400	3000

LABEL
Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled

with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GMBH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITTING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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